

SSC8530GN4

Dual N-Channel Enhancement MOSFET

> Features

VDS	VGS	RDSON Typ.	ID
201/	1301/	10mR@10V	18A
30V	±20V	12.5mR@4V5	10A

> Description

SSC8530GN4 uses advanced trench technology to provide excellent RDSON and low gate charge. The complementary MOSFETS may be used to form a level shifted high side switch, and for a host of other applications.

Applications

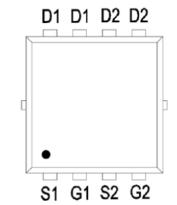
- Inverter
- DC-DC converter
- Half and Full Bridge Topology
- Wireless Charging

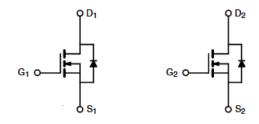
> Ordering Information

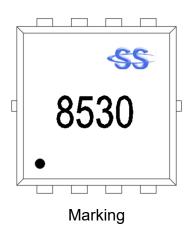
Device	Package	Shipping
SSC8530GN4	PDFN3.3X3.3	5000/Reel

Pin configuration

Top view









➤ Absolute Maximum Ratings(T_A=25°C unless otherwise noted)

Symbol	Parameter		Ratings	Unit
V _{DSS}	Drain-to-Source Voltage		30	V
V _{GSS}	Gate-to-Source Voltage		±20	V
l ₋	Continuous Drain	TC=25°C	18	Α
l _D	Current ^d	TC=100°C	13	А
I _{DM}	Pulsed Drain Co	urrent ^b	55	А
I _{AS}	Avalanche Current b L=0.5mH		14	А
E _{AS}	Avalanche Energy ^b L=0.5mH		49	mJ
	Continuous Drain	TA=25°C	12	А
I _D	Current ^a	TA=70°C	9	Α
P _D		TC=25°C	20	W
	Power Dissipation ^c	TC=100°C	8	W
P _{DSM}	Davis Diadia dia 3	TA=25°C	2.7	W
	Power Dissipation ^a	TA=70°C	1.7	W
TJ	Operation junction temperature		-55 to 150	°C
T _{STG}	Storage temperature range		-55 to 150	°C

➤ Thermal Resistance Ratings(T_A=25°C unless otherwise noted)

Symbol	Parameter	Ratings	Unit
Reja	Junction-to-Ambient Thermal Resistance ^a	45	°C 041
R _θ JC	Junction-to-Case Thermal Resistance	6	°C/W

Note:

- a. The value of R_{θ,JA} is measured with the device mounted on 1 in² FR-4 board with 2oz.copper,in a still air environment with T_A=25°C. The value in any given application depends on the user is specific board design. The current rating is based on the t≤10s thermal resistance rating.
- b. Repetitive rating, pulse width limited by junction temperature.
- c. The power dissipation P_D is based on $T_{J(MAX)}$ =150°C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heat sinking is used.
- d. The maximum current rating is package limited.

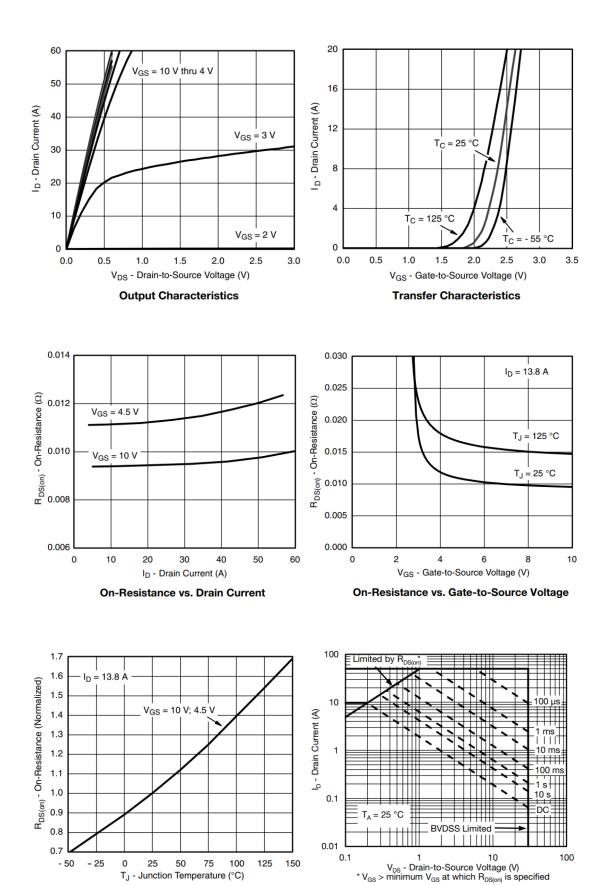


➤ **Electronics Characteristics**(T_A=25 °C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Тур.	Max	Unit	
V _{(BR)DSS}	Drain-Source Breakdown Voltage	VGS=0V , ID=250uA	30			V	
V _{GS (th)}	Gate Threshold Voltage	VDS=VGS , ID=250uA	1	1.5	2	V	
Б	Drain-Source On-	VGS=10V , ID=20A		10	12	2 mR	
R _{DS(on)}	Resistance	VGS=4.5V , ID=10A		12.5	15	mĸ	
I _{DSS}	Zero Gate Voltage Drain Current	VDS=24V , VGS=0V			1	uA	
I _{GSS}	Gate-Source leak	VGS=±20V , VDS=0V			±100	nA	
G _{FS}	Transconductance	VDS=5V , ID=10A		10		S	
V _{SD}	Forward Voltage	VGS=0V, IS=5A		0.8	1.3	V	
Rg	Gate Resistance	VGS=0V, f=1MHZ		2.5		R	
Ciss	Input Capacitance			770			
Coss	Output Capacitance	VDS=15V , VGS=0V,		190		pF	
Crss	Reverse Transfer Capacitance	f=1MHZ		20			
Qg	Total Gate Charge	VDC-45V VCC-40V		16			
Qgs	Gate Source Charge	VDS=15V , VGS=10V,		5		nC	
Qgd	Gate Drain Charge	ID=10A		5.5			
T _{D(ON)}	Turn-on delay time			10			
Tr	Rise time	VDS=15V, VGS=10V,		12		n.	
T _{D(OFF)}	Turn-off delay time	RL=2R, RGEN=3R		18		ns	
Tf	Fall time			7			



➤ N-Channel Typical Characteristics(T_A=25°C unless otherwise noted)



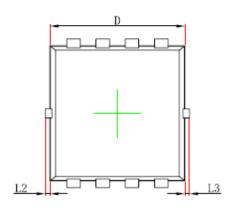
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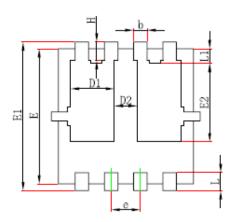
On-Resistance vs. Junction Temperature

Safe Operating Area, Junction-to-Ambient



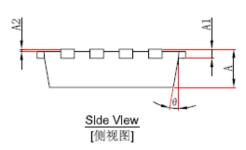
Package Information





Top Vlew [顶视图]

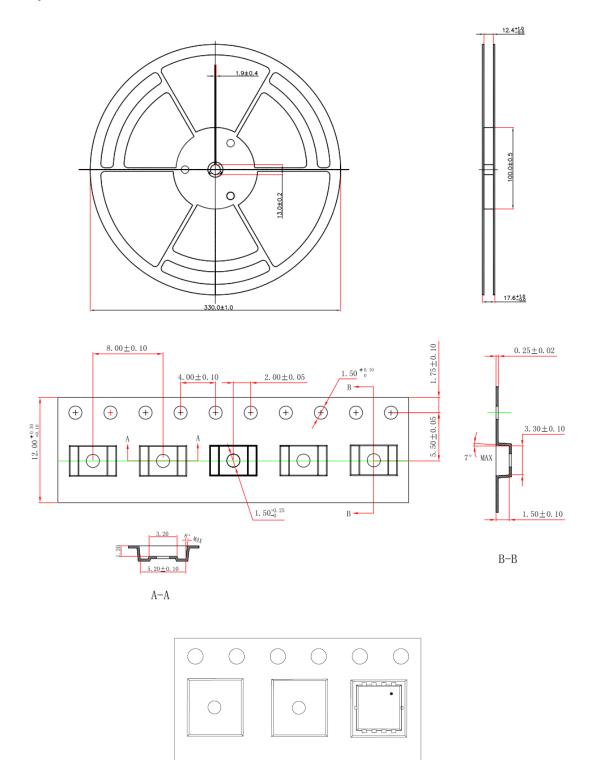
Bottom View [背视图]



Symbol	Dimensions In Millimeters		Dimensions In Inches		
	Min.	Max.	Min.	Max.	
Α	0.650	0.850	0.026	0.033	
A1	0.152	REF.	0.006 REF.		
A2	0~0).05	0~0.002		
D	2.900	3.100	0.114	0.122	
D1	0.935	1.135	0.037	0.045	
D2	0.280	0.480	0.011	0.019	
Е	2.900	3.100	0.114	0.122	
E1	3.150	3.450	0.124	0.136	
E2	1.535	1.935	0.060	0.076	
b	0.200	0.400	0.008	0.016	
е	0.550	0.750	0.022	0.030	
L	0.300	0.500	0.012	0.020	
L1	0.180	0.480	0.007	0.019	
L2	0~0.100		0~0.004		
L3	0~0.100		0~0.004		
Н	0.315	0.515	0.012	0.020	
θ	9°	13°	9°	13°	



Tape and Reel Data





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